



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AS SERIES

Ver: 08

Page: 1 / 20

# PRODUCT SPECIFICATION

PRODUCT : CERAMIC DISC CAPACITOR SAFETY RECOGNIZED

**TYPE: AS SERIES** 

**CUSTOMER:** 

**DOC. NO.: POE-D18-00-E-08** 

# APPROVED BY CUSTOMER

#### **VENDOR:**

☐ HITANO ENTERPRISE CORP.

7F-7, NO. 3, WU CHUAN 1ST ROAD, NEW TAIPEI INDUSTRIAL PARK, NEW TAIPEI CITY, TAIWAN, R.O.C.

TEL: +886 2 2299 1331 (REP.) FAX: +886 2 2298 2466 HITANO ENTERPRISE CORP. ®

#### **MAKER:**

☐ PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.

NO.277,HONG MING ROAD,EASTERN SECTION, GUANG ZHOU ECONOMIC AND TECHNOLOGY DEVELOPMENT ZONE,CHINA





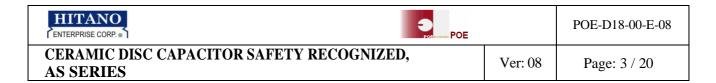
# CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AS SERIES

Ver: 08

Page: 2 / 20

### Record of change

Date	Version	Description	page
2014/11/19	0	First edition.	all
2016/1/27	1	<ol> <li>Review the Available lead code of Lead Configuration.</li> <li>Revised standard NO. of VDE.</li> </ol>	5 9
2019/1/18	2	Revised recognized NO. of CQC and ENEC (DEMKO).	9
2019/4/1	3	Add CQC approval marking on the body.	8
2019/4/24	4	<ol> <li>"Protrusion length": "2.0max (Or the end of lead wire may be inside the tape.)" revised to "+0.5to-1.0 (Or the end of lead wire may be inside the tape.)"</li> <li>Add "Soldering Recommendation"</li> </ol>	7 18
2019/12/11	5	<ol> <li>Review the Available lead code of Lead Configuration</li> <li>Add "8.3 Label samples"</li> </ol>	5 14
2020/4/22	6	1. Review the bulk packing quantity of the code of 14th to 15th $\geq$ 12.	14
2021/9/9	7	<ol> <li>Delete Walsin &amp; POE logo.</li> <li>Add "C" code Pitch 12.5mm.</li> </ol>	1 4,5,7,14
2022/4/18	8	<ol> <li>Add Applied voltage in 9.1 Caution (Rating):</li> <li>Add 9.3.4 List of substances that affect the insulation strength of coating.</li> </ol>	16 18



# **Table of Contents**

No.	Item	Page
1	Part number for SAP system	4
2	Mechanical	5
3	Part numbering/T.C/Capacitance/ Tolerance/Diameter	6
4	Taping format	7
5	Marking	8
6	Scope	9
7	Specification and test method	10~13
8	Packing specification	14
9	Notices	15~18
10	Soldering Recommendation	19
11	Drawing of Internal Structure and material list	20

#### 1. Part number for SAP system:

(Ex.) YU = 0AS = 472 = M = 14 = 0 = L = 20 = C = 0 = H(1) (2) (3) (4) (5) (6) (7) (8) (9) (10) (11)

(1) Temperature characteristic (identified code)

CODE	Temperature characteristic	Cap. Change
YP	Y5P	±10%
YU	Y5U	-55% to +20%

- (2) TYPE (identified by 3-figure code) :  $0AS = AS Type(X1:760V \sim /Y1:500V \sim )$ ,
- (3) Capacitance (identified by 3-figure code):EX.472=4700pF
- (4) Capacitance tolerance (identified by code): K:±10%,M:±20%
- (5) Nominal body diameter dimension (identified by 2-figure code): 07--Dmax8.0mm, 08--Dmax9.0mm...
- (6)Internal code: 0--Normal, other code--Special control
- (7) Lead Style: Refer to "2. Mechanical".
- (8) Packing mode and lead length (identified by 2-figure code)

Taping Code	Description
AM	Ammo box and product pitch: 25.4 mm

Bulk Code	Description			
03	Lead length : 3.0mm			
3E	Lead length : 3.5mm			
04	Lead length : 4.0mm			
4E	Lead length : 4.5mm			
20	Lead length : 20mm			

#### (9) Length tolerance

•					
Code	Description				
A	±0.5 mm (only for kink lead type)	Short lead			
В	±1.0 mm	Short lead			
C	Min.	Long lead			
D	Taping special purpose	Taping			

#### (10) Pitch

Code	Description
0	10±1 mm
A	10±0.5 mm
С	12.5± 0.8 mm

#### (11) Epoxy Resin Code

Code	Description	
Н	Halogen and Pb free, epoxy resin.	



#### 2. Mechanical:

Encapsulation: Epoxy resin, flammability UL94 V-0

### Available lead code (unit: mm):

Available lead code (unit. lilli).								
Lead type	SAP P/N (13-17)digits	Pitch (F)	Lead Length (L)	Packing	Lead Configuration			
	L03B0	$10 \pm 1.0$	$3.0 \pm 1.0$					
	L4EB0	10 ± 1.0	$4.5 \pm 1.0$		D max. T max.			
	L05B0	10 ± 1.0	5.0 ± 1.0					
Lead style: Lor B	L03BC	$12.5 \pm 0.8$	$3.0 \pm 1.0$	Bulk	For			
Type L or B	L3EAC	$12.5 \pm 0.8$	$3.5 \pm 0.5$		L≧20mm			
Straight lead	L4EBC	$12.5 \pm 0.8$	$4.5 \pm 1.0$		e			
	L20C0	10 ± 1.0	20 min.		'      For			
	L20CC	$12.5 \pm 0.8$	20 min.		L<20mm			
	BAMD0	$10 \pm 1.0$	Refer to "4.					
	BAMDC	$12.5 \pm 0.8$	Taping format"	Tap. Ammo				
	G03B0	10 ± 1.0	3.0 ± 1.0		D max.			
Lead style: G	G4EB0	10 ± 1.0	4.5 ± 1.0	Bulk				
Type G Straight lead	G05B0	10 ± 1.0	5.0 ± 1.0		6 1 6 4 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6			
	GAMD0	10 ± 1.0	Refer to "4. Taping format"	Tap. Ammo				
	D03A0	$10 \pm 1.0$	$3.0 \pm 0.5$		D.may T			
	D3EA0	$10 \pm 1.0$	$3.5 \pm 0.5$		D max.			
	D04A0	$10 \pm 1.0$	$4.0 \pm 0.5$					
Lead style: D	D03AC	$12.5\pm0.8$	$3.0 \pm 0.5$	Bulk	(			
Type D	D3EAC	$12.5 \pm 0.8$	$3.5 \pm 0.5$					
Vertical kink	D04AC	$12.5\pm0.8$	$4.0 \pm 0.5$		in the second se			
lead	D20C0	$10 \pm 1.0$	20 min.		F - 1 + 1 + 1 + 1 + 1 + 1 + 1 + 1 + 1 + 1			
	DAMD0	$10 \pm 1.0$	Refer to "4.	Tap. Ammo	Ø d+ + Lød			
	DAMDC	$12.5\pm0.8$	Taping format"	тар. Аншю				
	X03A0	10 ± 1.0	$3.0 \pm 0.5$		D max. T max.			
	X3EA0	$10 \pm 1.0$	$3.5 \pm 0.5$					
Lead style : X Type X	X04A0	10 ± 1.0	$4.0 \pm 0.5$	Bulk				
Outside kink lead	X03AC	$12.5 \pm 0.8$	$3.0 \pm 0.5$		2.0 max.			
	X3EAC	$12.5 \pm 0.8$	$3.5 \pm 0.5$		[			
	X04AC	$12.5 \pm 0.8$	$4.0 \pm 0.5$		₩ F - ₩ <b>                   </b>			
	XAMD0	10 ± 1.0	Refer to "4. Taping format"	Tap. Ammo				

<sup>\*</sup> Lead diameter  $\Phi$ d: 0.55 +/-0.05mm

<sup>\*</sup>e (Coating extension on leads): 3.0mmMax for straight lead style, not exceed the kink for kink lead.



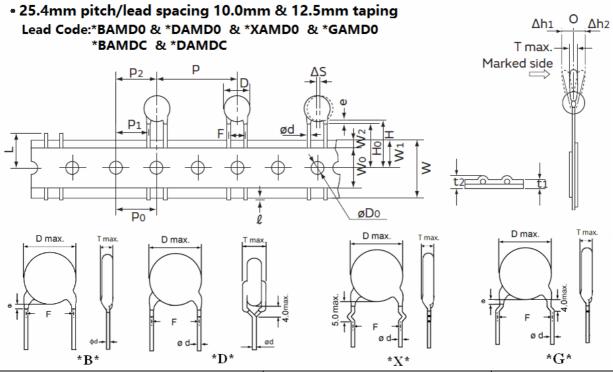
### 3. Part numbering/T.C/Capacitance/ Tolerance/Diameter:

					Dimens	sion (unit	:mm)	
SAP P/N	T.C.	Capacitance(pF)	Tolerance	D(max.)	T(max.)		F	Φd
				D(maxi)	1 (1114/11)	Bulk	Tap.	1.0
YP*AS101K070*		100 pF		8.0				
YP*AS151K070*		150 pF		8.0				
YP*AS221K070*		220 pF		8.0				
YP*AS331K070*	Y5P	330 pF	±10%	8.0				
YP*AS471K080*	131	470 pF	±10%	9.0				
YP*AS561K090*		560 pF		10.0	5.5	10.0 Or 12.5	10	0.55+/-0.05
YP*AS681K090*	1	680 pF		10.0				
YP*AS102K110*		1000 pF		12.0			10	
YU*AS102M080*		1000 pF		9.0		12.3		
YU*AS152M090*		1500 pF		10.0				
YU*AS222M120*	Y5U	2200 pF	. 200/	13.0				
YU*AS332M120*		3300 pF	±20%	13.0				
YU*AS392M130*		3900 pF		14.0				
YU*AS472M140*		4700 pF		15.0				

<sup>•</sup> The minimum thickness of coating (reinforced insulation) is 0.4mm.

HITANO ENTERPRISE CORP. ©		POE-D18-00-E-08
CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AS SERIES	Ver: 08	Page: 7 / 20

### 4. Taping format:



		41			
POE Part Numb	er	*BAMD0 / *DAMD0 *XAMD0 / *GAMD0	*BAMDC / *DAMDC		
Item	Symbol	Dimensions(mm)	Dimensions(mm)		
Pitch of component	P	25.4 ± 2	25.4 ± 2		
Pitch of sprocket	P0	12.7 ± 0.3	$12.7 \pm 0.3$		
Lead spacing	F	10.0 ± 1.0	$12.5 \pm 0.8$		
Length from hole center to component center	P2	12.7 ± 1.5	12.7 ± 1.5		
Length from hole center to lead	P1	$7.7 \pm 1.5$	$6.2 \pm 1.5$		
Body diameter	D	See the "3. Part numbering/T.C/Capacit	ance/Tolerance/Diameter"		
Deviation along tape, left or right	△ S	$0 \pm 2.0$			
Carrier tape width	W	18.0 +1/ -0.5	j		
Position of sprocket hole	W1	$9.0 \pm 0.5$			
Lead distance between the kink and center of sprocket hole	НО	18.0 +2.0/-0 (For: *DAMD0 & *XAMD0&*GAMD0)	18.0 +2.0/-0 (For: *DAMDC)		
Lead distance between the bottom of body and the center of sprocket hole	Н	20.0+1.5/-1.0 (For: *BAMD0)	20.0+1.5/-1.0 (For: *BAMDC)		
Length from the terminal of the lead wire to the edge of carrier tape	$\ell$	+0.5 to -1.0 (Or the end of lead wire may be	inside the hole-down tape. )		
Diameter of sprocket hole	D0	$4.0 \pm 0.2$			
Lead diameter	φd	$0.55 \pm 0.05$			
Total tape thickness	t1	$0.6 \pm 0.3$			
Total thickness, tape and lead wire	t2	1.5 max.			
Deviation across tape	△ h1/△ h2	2.0 max.			
Portion to cut in case of defect	L	11.0 max.			
Hole-down tape width	W0	0 8.0 min			
Hole-down tape distortion	W2	$1.5 \pm 1.5$			
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink leads			
Body thickness	T	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"			



#### 5. Marking:

. Marking:			
1.Type Designation	AS		
2.Nominal Capacitance	Identified by 3-Figure Cod	e. Ex. 100pF→"10	)1" <sup>→</sup> 4700pF <del>→</del> "472"
3.Capacitance Tolerance	K:±10%,M:±20%		
4.Company Name Code(Trade mark)	K		
5. Products ID	Manufactory: "_": H C:Pan overseas fr (Guangzhou) (F "I	→ Individ	lual specification code Manufacture month: 1:January 2:Feruary : 9:September O:October N:November
6.Approved Monogram:			D:December
(1) VDE approval mark	IEC 60384-14 Class code: X1	: 760V~ , Y1 : :	500V~
(2) UL approval mark	<b>A</b> or <b>c A</b> <sup>8</sup>		
	Marking ex.		
Two sides ma (for SAP part number 10-11 o		(for SAP p	side marking art number 10-11 "08" products )
AS101K X1:760V~ Y1:500V~	710 OYE 2 C61234		5472M 5472M 710 X1:760V~ Y1:500V~

2<u>C</u>61234

\* Marking by the laser.

\*"C": Marked with code "\_" stand for Halogen and Pb free epoxy resin.

\* "· ": Individual specification code, it is added under the lot no.



#### 6. Scope:

This specification applies to ceramic insulated capacitors disk type used in electronic equipment.

#### 6.1 Applicable safety standard

This specification applies to the VDE, ENEC10,UL/CUL approved ceramic capacitors disc type for antenna coupling, line-by-pass and across-the-line. X1, Y1 capacitor based on IEC60384-14.

#### 6.2 Safety standards approval and recognized no.

Safety Standard	Standard No.	Subclass	W.V.	Recognized No.
		X1	760VAC	E146544
UL/CUL	UL/CUL   ANSI/UL 60384-14:2013	Y1	500VAC	(FOWX2/FOWX8)
VDE	EN 60384-14:2013	X1	760VAC	
(ENEC)	IEC60384-14:2013	Y1	500VAC	40039265
ENEC	EN 60384-14:2013/ A1:2016, EN	X1	760VAC	ENEC-01964-A1
(I)FMK())   ·	60384-14:2013	Y1	500VAC	ENEC-01904-A1
CQC	GB/T6346.14-2015	X1	760VAC	CQC18001186964
OQC	GB/16346.14-2015	Y1	500VAC	00010001100904

#### 7. Specification and test method:

- 7.1 Operating Temperature Range: -40 to +125  $^{\circ}$ C
- 7.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature 15~35°C, relative humidity 45~75% and atmospheric pressure 860~1060hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference condition. (temperature  $20\pm2^{\circ}\text{Cor}25\pm2^{\circ}\text{C}$ , relative humidity  $60\sim70\%$  and atmospheric pressure  $860\sim1060\text{hpa.}$ )

#### 7.3 Performance:

No	Items		Performance	Testing method		
7.3.1	Appearance And dimension		The appearance and dimension shall be as given in section 3.	Visual check.		
7.3.2	Ma	rking	To be easily legible.	Visual check.		
	Between terminals		No failure.	The capacitors shall not be damage when AC4000V (rms.) are applied between the lead wires for 60sec. (Charge/Discharge current ≤ 50mA.)		
7.3.3	Withstand voltage	Body Insulation	No failure.	First, the terminals of the capacitor should be connected together.  Then, a metal foil should be closely wrapped around the body of the capacitor to the distance of about 3 to 6mm from each terminal. Then, the capacitor should be inserted into a container filled with metal balls of about 1mm diameter.  Finally, AC4000V (r.m.s.)<50/60Hz> is applied for 60 s between the capacitor lead wires and metal balls. (Charge/Discharge current ≤ 50mA.)		
7.3.4	Insulation Resistance	Between terminals	10000MΩ or more.	The insulation resistance shall be measured with DC500±50V within 60±5sec of charging.		
7.3.5	Capa	citance	Within specified tolerance.	Y5P&Y5U: The capacitance shall be measured at 20±2℃ with 1kHz±20% and 5V(rms.) or less.		
7.3.6		pation r(D.F.)	Y5P、Y5U: D.F.≦2.5%			
7.3.7	Temperature Characteristic		Char. Capacitance Change Y5P Within ± 10% Y5U Within ± 55%	The capacitance measurement shall be made at each step specified in Table .  Step 1 2 3 4 5  Temp.(°C) +20±2 -25±2 +20±2 +85±2 +20±2  Pre-treatment:  Capacitor shall be stored at 125±2°C for 1hour.then placed at *1 room condition for 24±2hours before initial measurements.		
7.3.8	Solderability of Leads		Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.	The lead wire of capacitor should be dipped into molten solder for $5 \pm 0.5$ sec.  The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires.  Temp. of solder: Lead Free Solder (Sn-3Ag-0.5Cu) $245\pm5$ °C		

<sup>%</sup> "room condition" temperature : 15~35°C, humidity : 45~75%, atmospheric pressure : 86~106kPa

<sup>&</sup>quot;C" expresses nominal capacitance value (pF).





# CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AS SERIES

Ver: 08

Page: 11 / 20

No	Iten	ns	Performance	Testing method
		Tensile	Lead wire shall not cut off capacitor shall not be broken.	As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N and keep it for 10±1 sec.
7.3.9 Robustness of Termination		Bending	Lead wire shall not cut off. Capacitor shall not be broken.	With the termination in its normal position, the specimen is held by its body in such a manner that the axis of the termination is vertical; a mass applying a force of 5N is then suspended from the end of the termination. The body of the specimen is then inclined, within a period of 2 to 3sec, through an angle of approximately 90° in the vertical plane and then returned to its initial position over the same period of time; this operation constitutes one bend. One bend immediately followed by a second bend in the opposite direction.
		Appearance	No marked defect.	As shown in figure, the lead wires should be immersed in solder of $350 \pm 10$ °C or $260 \pm 5$ °C up to 1.5 to 2.0 mm from
		I.R.	1000 MΩ min.	the root of terminal for $3.5 \pm 0.5$ sec ( $10 \pm 1$ sec. for $260 \pm 5$ °C ).
		Dielectric Strength	Per item7.3. 3	Thermal Capacitor
7.3.10	Soldering Effect (Non-Preheat)	Capacitance	Y5P,Y5U: Within ±10 %	Pre-treatment:  Capacitor shall be stored at 125±2°C for 1hour.then placed at *1 room condition for 24±2hours before initial measurements.  Post-treatment:  Capacitor shall be stored for 1 to 2hours at *1 room condition.
		Appearance	No marked defect.	First the capacitor should be stored at 120+0/-5 °C for 60 +0/-5 sec.  Then , as in figure , the lead wires should be immersed solder of 260+0/-5 °C up to 1.5 to 2.0 mm from the root of terminal for 7.5+0/-1 sec.  Thermal Capacitor  Capacitor  L.5  L.5  L.5  L.5  L.5  L.5  L.5  L.
7.3.11	Soldering	I.R.	$1000~\mathrm{M}\Omega$ min.	Molten Solder
	Effect (On-Preheat)	Dielectric Strength	Per item 7.3.3	
		Capacitance	Y5P,Y5U: Within ±10%	Pre-treatment:  Capacitor shall be stored at 125±2°C for 1hour.then placed at *1 room condition for 24±2hours before initial measurements.  Post-treatment:  Capacitor shall be stored for 1 to 2hours at *1 room condition.

 <sup>&</sup>quot;room condition" temperature : 15~35℃, humidity : 45~75%, atmospheric pressure : 86~106kPa

<sup>&</sup>quot;C" expresses nominal capacitance value (pF)





# CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AS SERIES

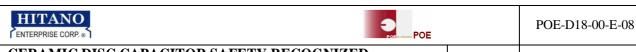
Ver: 08

Page: 12 / 20

No	Iten	ns	Performance	Testing method	
		Appearance	No marked defect.	Set the capacitor for 500±12hours at 40±2°C in 90 to 95%	
		Capacitance	Y5P: Within ±10%	relative humidity.	
	Humidity	Change	Y5U: Within ±20%	Pre-treatment:	
		D.F.	Y5P,Y5U: 5.0% max.	Capacitor shall be stored at 125±2°C for 1hour.then	
7.3.12	(Under steady State)	I.R.	Y5P&Y5U: 3000MΩmin.	placed at * 1 room condition for 24±2hours before initial measurements.	
	State)	Dielectric Strength	Per Item 7.3.3	Post-treatment: Capacitor shall be stored for 1 to 2hours at * 1room condition.	
		Appearance	No marked defect.	Apply the rated voltage for 500±12 hours at 40±2°C in	
		Capacitance	Y5P: Within ±10%	90 to 95% relative humidity.	
		Change	Y5U: Within ±20%	Pre-treatment:	
	Humidity	D.F.	Y5P,Y5U: 5.0% max.	Capacitor shall be stored at 125+2°C for 1hour then	
7.3.13	Loading	I.R.	Y5P&Y5U: 3000MΩmin.	placed at * room condition for 24±2hours before initial	
	Dielectric Per Itam 7.3.3 Post-treatment		Post-treatment:  Capacitor shall be stored for 1 to 2hours at *1room condition.		
		Appearance	No marked defect.	Impulse Voltage Each individual capacitor shall be subjected to 8kV	
		Capacitance Change  Y5P&Y5U: Within ±20% impulses for th applied to life to the applied to the		impulses for three times. After the capacitors are applied to life test.	
		I.R.	$3000 \mathrm{M}\Omega$ min.	0.5Vp 0.5Vp 0.5Vp	
7.3.14	Life	Dielectric Strength	Per Item 7.3 3	The specimen capacitors are placed in a circulating air oven for a period of 1000 hours. The air in the oven is maintained at a temperature of 125±3°C. Throughout the test, the capacitors are subjected to an AC850Vrms. alternating voltage of mains frequency.  Pre-treatment:  Capacitor shall be stored at 125±2°C for 1hour.then placed at *1 room condition for 24±2 hours before initial measurements.  Post-treatment:  Capacitor shall be stored for 1 to 2 hours at *1 room condition.	

<sup>%</sup> "room condition" temperature : 15~35°C, humidity : 45~75%, atmospheric pressure : 86~106kPa

<sup>&</sup>quot;C" expresses nominal capacitance value (pF).



Ver: 08

Page: 13 / 20

# CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AS SERIES

No **Items Performance** Testing method The specimens shall be individually wrapped in at least one but more than two complete layers of cheesecloth. The specimens shall be subjected to 20 discharges. The interval between successive discharges shall be 5 sec. The UAC shall be maintained for 2 min after the last discharge. Fig. 6 Active The cheesecloth shall 7.3.15 C1,2 : 1µF±10% L1 to 4 : 1.5mH±20% Flammability not be on fire. : 0.033µF±5% 10kV 16A Rod core choke : 3µF±5% 10kV R : 100Ω±2% : Capacitor under test : UR±5% Сx UAC : Fuse, Rated 10A UR : Rated Voltage Ut : Voltage applied to Ct The capacitor under test shall be held in the position which best promotes burning. Each specimen shall only be exposed once to flame. Time of exposure to flame: 30sec. Length of flame: 12±1mm Gas burner: Length 35mm min. Inside Dia.: 0.5±0.1mm Outside Dia.: 0.9mm max. The burning time Gas: Butane gas Purity 95% min. shall not be exceeded 7.3.16 Passive Flammability the time 30 sec. The Fig. 7 Testapecimen About 8mm tissue paper shall not ignite. Tissue =About 10mm (Hide books The capacitor should be subjected to 5 temperature cycles, Appearance No marked defect <Temperature Cycle time: 5cycles> Сар. DF Char. Temperature( $^{\circ}$ C) Time(min) Step Change -40+0/-3 30 Y5P ≦ ±10% DF≦5.0% Room temp. 3 Y5U ≤ ±20% DF≦7.5% **Temperat** 125+3/-0 3 30 7.3.17 ure Cycle  $3000 M\Omega$  min. Room temp. I.R. Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then placed at\* <sup>1</sup>room condition for 24±2hours. Dielectric strength | Per Item 7.3.3

Post-treatment:

Capacitor shall be stored for 1 to 2hours at \*1room condition.

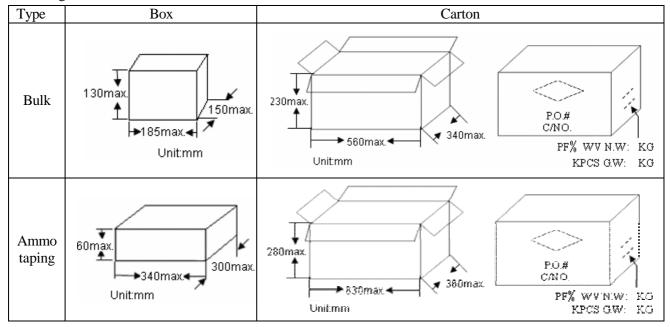
<sup>\* &</sup>quot;room condition" temperature: 15~35°C, humidity: 45~75%, atmospheric pressure: 86~106kPa

<sup>&</sup>quot;C" expresses nominal capacitance value (pF).



#### 8. Packing Baggage:

#### 8.1 Packing size:



#### 8.2 Packing quantity:

Packing type	The code of 14th to15th in SAP P/N	MPQ (Kpcs/Box)	Remark
	AM (The size code ≤ 11)	1	F=10mm
	AM (The size code≧ 12)	0.5	(Code -17th"A" or "0")
Taping	AM(Code -17th"C")	0.5	F=12.5mm
	AS	1	
	AT	0.5	

Packing type	Lead length	Size code of 10th to 11th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box
	Long lead	07~11	0.5	1.5
Bulk	(L≧20mm)	12-14	0.5	1
	Short lead	07~11	0.5	2
	(L<20mm)	12-14	0.5	1.5

#### 8.3 Label samples:



#### 9. Notices:

#### 9.1 Caution (Rating):

#### (1). Operating Voltage

Be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing this irregular voltage.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage
Positional measurement	V0-p	Vo-p	Vp-p

#### (2). Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

### (3). Test condition for withstanding Voltage

#### I. Test Equipment

Test equipment for AC withstanding voltage shall be used with the performance of the wave similar to 50/60 Hz sine waves.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

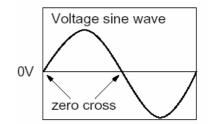
#### II. Voltage Applied Method

When the withstanding voltage is applied, capacitor's lead or terminal shall be firmly connected to the output of the withstanding voltage test equipment, and then the voltage shall be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the \*zero cross. At the end of the test time, the test voltage shall be reduced to near zero, and then capacitor's lead or terminal shall

be taken off the output of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.





#### III. Applied voltage

The voltages of Table shall be applied between the respective measuring points of 1 min for qualification approval and periodic testing and for a period of not less than 1 s for lot-by-lot quality conformance testing, a voltage proof test such as Test C shall be carried out only for qualification approval tests and periodic tests;

Attention is drawn to the fact that repetition of the voltage proof test by the user may damage the capacitor. If repetition of the voltage proof test is made by the user, the applied voltage should not be greater than 66% of the test voltage specified in Table .

Table -Voltage proof

	Class	Range of rated voltages	Test A	Test B or Test C
	X1	≤1 000 V	4,3 UR (d.c.) c	2 <i>U</i> R + 1 500 V (a.c.) with a minimum of 2 000 V (a.c.) a
Ī	Y1	≤500 V	4 000 V (a.c.)	4 000 V (a.c.)

a For Delta and T-connected capacitor units according to Figures 5b and 5c, the test voltage for terminals to case shall be the appropriate test voltage for the Y-capacitors. b The UR in this d.c. test is the rated a.c.voltage value.

#### Note:

Test A – Between terminations

Test B - Internal insulation

Test C – External insulation (applicable only to insulated capacitors in nonmetallic case or in insulated metal case)

Figure 5b – Delta by-pass capacitor (in metallic housing)

Figure 5c – Example of a T-connected by-pass capacitor (in non-metallic housing)

\*For capacitors with non-metallic housings, the earth connection is brought out as a separate termination as is shown in Figure 5c.

#### (4). Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.



#### 9.2 Caution (Storage and operating condition):

Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40 degrees centigrade and 15 to 85% for 6 months maximum and use within the period after receiving the capacitors.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

#### 9.3 Caution (Soldering and Mounting):

9.3.1 Vibration and impact:

Do not expose a capacitor or its leads to excessive shock or vibration during use.

9.3.2 Soldering:

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 degrees C. max.

Soldering iron wattage: 50W max.

Soldering time: 3.5 sec. max.

9.3.3 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time:5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."



# 9.3.4 List of substances that affect the insulation strength of coating:

#### **Epoxy resin solvent**

Category	Model		
Ketone	Acetone	Butanone	Cyclohexanone
Esters	Ethyl acetate	Dibutyl phthalate	
Chlorinated hydrocarbons	Dichloromethane		

#### **Epoxy resin thinner**

Category		Model	
		HK-66 (Alkyl g	lycidyl ether)
		501 (Butyl gly	vcidyl ether)
	Simple function group	690 (Phenyl Gl	ycidyl Ether )
		AGE (C12-14Aliphatic Pol	yalcohol Glycidyl Ether)
		692 (Benzyl Gl	ycidyl Ether)
Reactive diluentactivated thinner		D-678 (Neopentyl glyd	col diglycidyl ether)
	Two functional groups	622 (1,4-Butanediol diglycidyl ether)	
		669 (Ethylene glycol diglycidyl ether)	
		X-632 (Polypropylene glycol diglycidyl ether)	
		X-652 (1,6-Hexadiol diglycidyl ether)	
		D-691Epoxypropane o-methylphenyl ether	
		Anhydrous ethanol	Toluene
Non-activated thinner		Ethyl acetate	Dimethylbenzene
		Dimethyl formamide	Butyl acetate
		Acetone	Styrene
		Polyol	Benzyl alcohol

Note: The above substances should not contact the coating of the product body, otherwise it will affect the insulation strength of the product

#### 9.4 Caution (Handling):

Vibration and impact

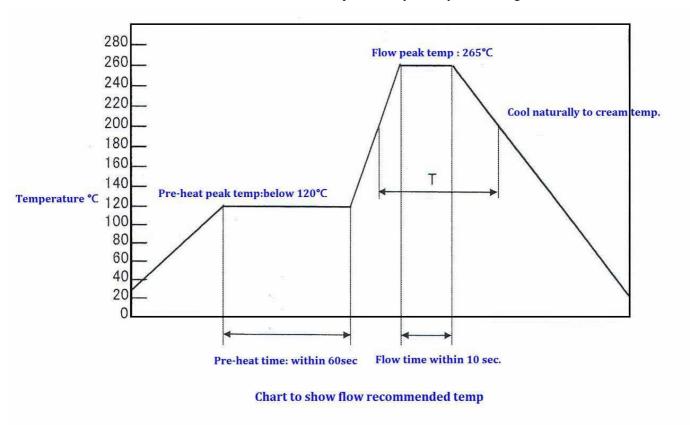
Do not expose a capacitor or its leads to excessive shock or vibration during use.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

#### 10. Soldering Recommendation:

#### 10.1 Wave Soldering Profile:

- Temperature conditions of the flow is recommended as shown in the chart
- Must implement the pre-heat
- Maximum peak flow temperature is recommended 265°C
- Time "T" implement in the chart recommended within 20 sec. it temperature exceed 200°C
- Take care with the flow solder not to touch the capacitor body directly at mounting



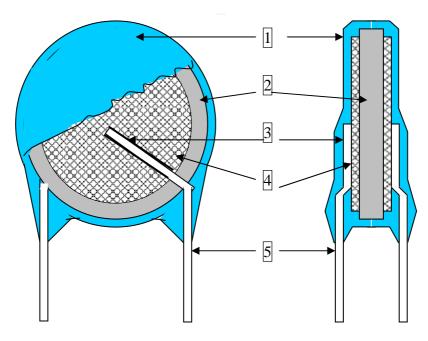
#### 10.2 Recommended Reworking Conditions with Soldering Iron:

- Temperature of iron-tip: 400 degrees C. max.
- Soldering iron wattage: 50W max.
- Soldering time: 3.5 sec. max.
- Distance from coating body: 2 mm (min.)

#### 10.3 Reflow-Soldering: Lead Ceramic Cap. should not be soldered by reflow-soldering.



# 11. Drawing of internal structure and material list:



#### Remarks:

No.	Part name	Material	Model/Type	Component
1	Insulation Coating	Epoxy polymer	EF-150 PCE-300 ECP-357	Epoxy resin Pigment (Blue / UL 94 V-0) The minimum thickness of coating (reinforced insulation) is 0.4mm
2	Dielectric Element	Ceramic	Y5P/Y5U	BaTiO <sub>3</sub>
3	Solder	Tin-silver	Sn96.5-Ag3-Cu0.5	Sn96.5-Ag3-Cu0.5
4	Electrodes	Ag	SP-160PL SP-260PL	Silver · Glass frit
5	Leads wire	Tinned copper clad steel wire	0.55±0.05mm	Substrate metal: Fe & Cu Surface plating: Sn 100%(3~7μm)